Analog Power AM3464N

# N-Channel 60-V (D-S) MOSFET

### **Key Features:**

- Low r<sub>DS(on)</sub> trench technology
- · Low thermal impedance
- Fast switching speed

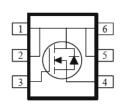
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- DC/DC Conversion Circuits
- Motor Drives

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)}(m\Omega)$	I□ (A)		
60	23 @ V <sub>GS</sub> = 10V	7.7		
	30 @ V <sub>GS</sub> = 4.5V	6.7		







ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	Limit	Units	
Drain-Source Voltage		$V_{DS}$	60	V	
ate-Source Voltage			±20	V	
Continuous Drain Comment <sup>®</sup>	T <sub>A</sub> =25°C	ı	7.7		
Continuous Drain Current <sup>a</sup>	T <sub>A</sub> =70°C	l <sub>D</sub>	6.2	Α	
Pulsed Drain Current <sup>b</sup>	I <sub>DM</sub>	30			
Continuous Source Current (Diode Conduction) a		I <sub>S</sub>	3.1	Α	
Device Discipation 8	T <sub>A</sub> =25°C	P <sub>D</sub>	2	W	
Power Dissipation <sup>a</sup>	T <sub>A</sub> =70°C	I P	1.3	VV	
Operating Junction and Storage Temperature Range		$T_J, T_{stq}$	-55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter			Maximum	Units	
Maximum Junction-to-Ambient <sup>a</sup>	t <= 10 sec	$R_{\theta JA}$	62.5	°C/W	
IMAXIMUM Sunction-to-Ambient	Steady State	IXOJA	110		

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#### Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

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### **Electrical Characteristics**

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static							
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250 \text{ uA}$	1			V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA	
Zero Gate Voltage Drain Current	lass	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$			1	uA	
Zero Gate Voltage Brain Gurrent	I <sub>DSS</sub>	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	12			Α	
Drain-Source On-Resistance <sup>a</sup>	r	$V_{GS} = 10 \text{ V}, I_{D} = 6 \text{ A}$			23	mΩ	
Drain-Source On-Resistance	r <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$			30		
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_{D} = 6 \text{ A}$		27		S	
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_{S} = 1.6 \text{ A}, V_{GS} = 0 \text{ V}$		0.74		V	
		Dynamic <sup>b</sup>					
Total Gate Charge	$Q_g$	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V},$		12			
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 30 \text{ V}, V_{GS} = 4.3 \text{ V},$ $I_{D} = 6 \text{ A}$		4.5		nC	
Gate-Drain Charge	$Q_gd$	1B = 0 A		3.5			
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DS} = 30 \text{ V}, R_{L} = 5 \Omega,$		5			
Rise Time	t <sub>r</sub>	$V_{DS} = 30 \text{ V}, K_L - 3 \Omega,$ $I_D = 6 \text{ A},$		5		ne	
Turn-Off Delay Time	$t_{d(off)}$	$V_{GEN} = 10 \text{ V}, R_{GEN} = 6 \Omega$		36		ns	
Fall Time	t <sub>f</sub>	V GEN = 10 V, 1 (GEN = 0.12		11			
Input Capacitance	C <sub>iss</sub>			1597			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ Mhz}$		92		pF	
Reverse Transfer Capacitance	$C_{rss}$			99			

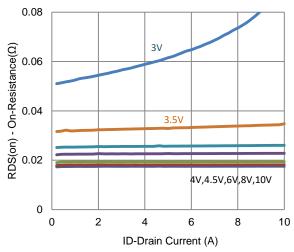
#### Notes

- Pulse test: PW <= 300us duty cycle <= 2%.
- Guaranteed by design, not subject to production testing.

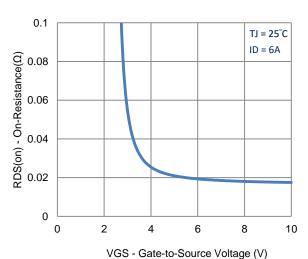
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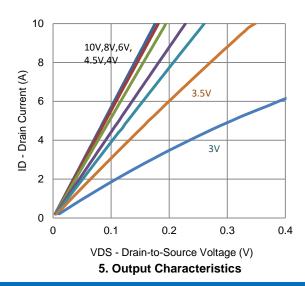
### **Typical Electrical Characteristics**

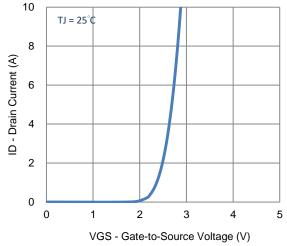


#### 1. On-Resistance vs. Drain Current

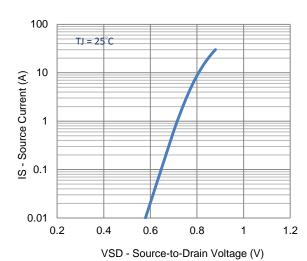


3. On-Resistance vs. Gate-to-Source Voltage

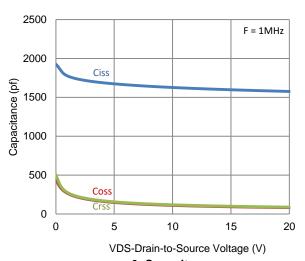




2. Transfer Characteristics



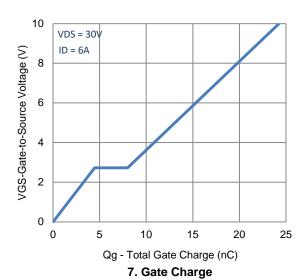
4. Drain-to-Source Forward Voltage

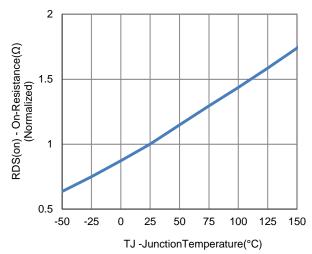


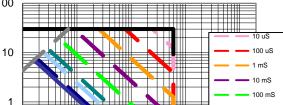
6. Capacitance

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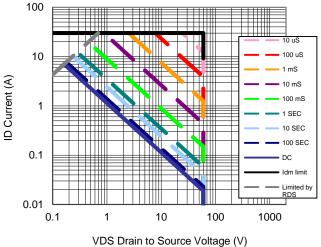
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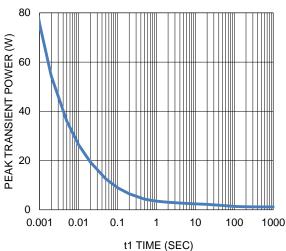






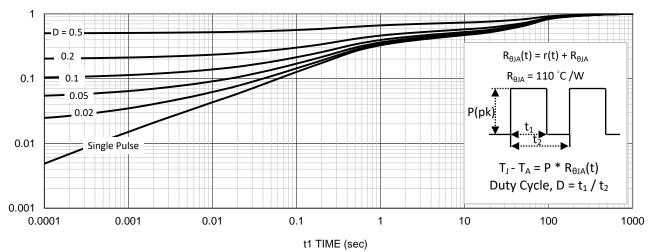
8. Normalized On-Resistance Vs **Junction Temperature** 





9. Safe Operating Area

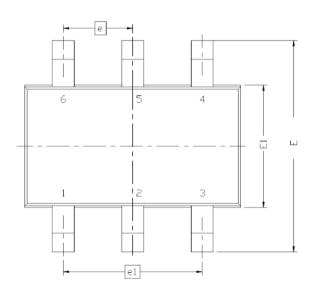
10. Single Pulse Maximum Power Dissipation



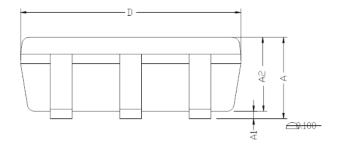
11. Normalized Thermal Transient Junction to Ambient

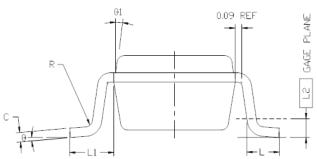
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## **Package Information**



DIM.	MILLIMETERS				
DIM	MIN	NDM	MAX		
Α	0.935		1.10		
A1	0.01		0.10		
A2	0.70		1.00		
b	0.25	0.32	0.40		
$\subset$	0.10	0.15	0.20		
D	2.95	3.05	3.10		
Ε	2.70	2.85	2.98		
E1	1.55	1.65	1.70		
6	0.95 BSC				
L	0.30		0.60		
L1	0.60REF				
L2	0.25BSC				
R	0.10				
θ	0?	4?	8?		
θ1	7? N□M				





#### Note:

- 1. All Dimension Are In mm.
- Package Body Sizes Exclude Mold Flash, Protrusion Or Gate Burrs. Mold Flash, Protrusion Or Gate Burrs Shall Not Exceed 0.10 mm Per Side.
- Package Body Sizes Determined At The Outermost Extremes Of The Plastic Body Exclusive Of Mold Flash, Tie Bar Burrs, Gate Burrs And Interlead Flash, But Including Any Mismatch Between The Top And Bottom Of The Plastic Body.
- 4. The Package Top May Be Smaller Than The Package Bottom.
- Dimension "B" Does Not Include Dambar Protrusion. Allowable Dambar Protrusion Shall Be 0.08 mm Total In Excess Of "B" Dimension At Maximum Material Condition. The Dambar Cannot Be Located On The Lower Radius Of The Foot.